N-Channel 60-V (D-S) MOSFET

Key Features:

- Low r_{DS(on)} trench technology
- · Low thermal impedance
- · Fast switching speed

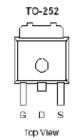
Typical Applications:

- PoE Power Sourcing Equipment
- PoE Powered Devices
- Telecom DC/DC converters
- White LED boost converters

| PRODUCT SUMMARY | | | | |
|---------------------|-----------------------------|--------------------|--|--|
| V _{DS} (V) | $r_{DS(on)}(m\Omega)$ | I _D (A) | | |
| 60 | 38 @ V _{GS} = 10V | 30 | | |
| 60 | 50 @ V _{GS} = 4.5V | 26 | | |







| ABSOLUTE MAXIMUM RATINGS ($T_A = 25^{\circ}$ C UNLESS OTHERWISE NOTED) | | | | | | |
|---|----------------------|-----------------------------------|------------|-------|--|--|
| Parameter | | Symbol | Limit | Units | | |
| Drain-Source Voltage | | V_{DS} | 60 | V | | |
| Gate-Source Voltage | | V_{GS} | ±20 | V | | |
| Continuous Drain Current | T _C =25°C | I _D | 30 | Α | | |
| Pulsed Drain Current ^b | I _{DM} | 100 | A | | | |
| Continuous Source Current (Diode Conduction) | | I _S | 30 | Α | | |
| Power Dissipation | T _C =25°C | P_{D} | 50 | W | | |
| Operating Junction and Storage Temperature Range | | T _J , T _{stg} | -55 to 175 | °C | | |

| THERMAL RESISTANCE RATINGS | | | | | |
|--|-----------------|---------|-------|--|--|
| Parameter | Symbol | Maximum | Units | | |
| Maximum Junction-to-Ambient ^a | $R_{\theta JA}$ | 40 | °C/W | | |
| Maximum Junction-to-Case | $R_{\theta JC}$ | 3 | C/VV | | |

Notes

a. Surface Mounted on 1" x 1" FR4 Board, drain pad using 2 oz copper, value dependent on PC board thermal characteristics

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b. Pulse width limited by maximum junction temperature

Typical Electrical Characteristics

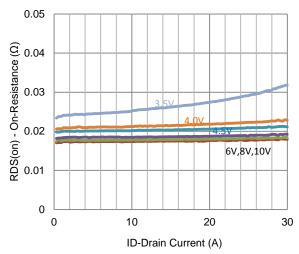
| Parameter | Symbol | Test Conditions | Min | Тур | Max | Unit | |
|---------------------------------|---------------------|---|-----|------|------|------|--|
| | | Static | | | | | |
| Gate-Source Threshold Voltage | $V_{GS(th)}$ | $V_{DS} = V_{GS}, I_{D} = 250 \text{ uA}$ | 1 | | | V | |
| Gate-Body Leakage | I _{GSS} | $V_{DS} = 0 \text{ V}, V_{GS} = 20 \text{ V}$ | | | ±100 | nA | |
| Zero Gate Voltage Drain Current | | $V_{DS} = 48 \text{ V}, V_{GS} = 0 \text{ V}$ | | | 1 | uA | |
| Zero Gate Voltage Drain Current | I _{DSS} | $V_{DS} = 48 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55^{\circ}\text{C}$ | | | 25 | uA | |
| On-State Drain Current | I _{D(on)} | $V_{DS} = 5 \text{ V}, V_{GS} = 10 \text{ V}$ | 34 | | | Α | |
| Drain-Source On-Resistance | r | $V_{GS} = 10 \text{ V}, I_{D} = 20 \text{ A}$ | | | 38 | mΩ | |
| Dialii-Source Ori-Nesistance | r _{DS(on)} | $V_{GS} = 4.5 \text{ V}, I_D = 17 \text{ A}$ | | | 50 | | |
| Forward Transconductance | g _{fs} | $V_{DS} = 15 \text{ V}, I_{D} = 20 \text{ A}$ | | 22 | | S | |
| Diode Forward Voltage | V_{SD} | $I_{S} = 15 \text{ A}, V_{GS} = 0 \text{ V}$ | | 0.86 | | V | |
| | | Dynamic | | | | | |
| Total Gate Charge | Q_g | | | 16.5 | | nC | |
| Gate-Source Charge | Q_{gs} | $V_{DS} = 30 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 20 \text{ A}$ | | 5.3 | | | |
| Gate-Drain Charge | Q_{gd} | | | 8.6 | |] | |
| Turn-On Delay Time | t _{d(on)} | | | 10.0 | | | |
| Rise Time | t _r | $V_{DD} = 30 \text{ V}, R_L = 1.5 \Omega, I_D = 20 \text{ A},$ | | 12.8 | | nc | |
| Turn-Off Delay Time | t _{d(off)} | V_{GEN} = 10 V, R_{GEN} = 6 Ω | | 53.1 | | ns | |
| Fall Time | t _f |] | | 18.6 | | | |
| Input Capacitance | C _{iss} | | | 1711 | | | |
| Output Capacitance | C _{oss} | $V_{DS} = 15 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$ | | 147 | | pF | |
| Reverse Transfer Capacitance | C_{rss} | | | 134 | | | |

Notes

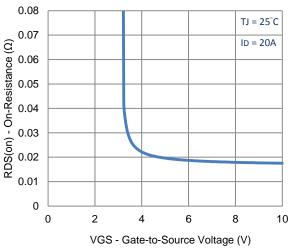
- a. Pulse test: PW <= 300us duty cycle <= 2%.
- b. Guaranteed by design, not subject to production testing.

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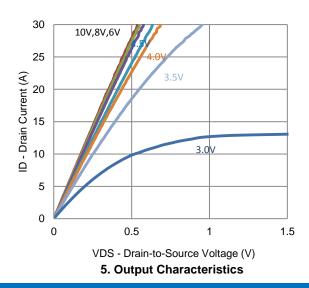
Typical Electrical Characteristics

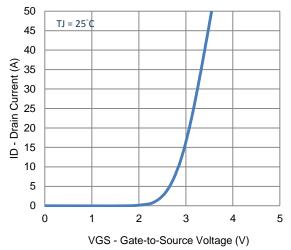


1. On-Resistance vs. Drain Current

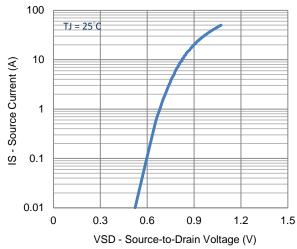


3. On-Resistance vs. Gate-to-Source Voltage

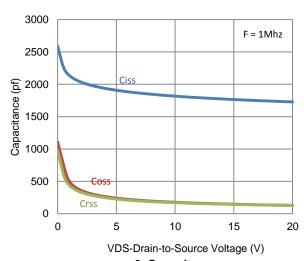




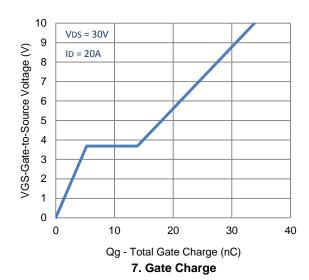
2. Transfer Characteristics

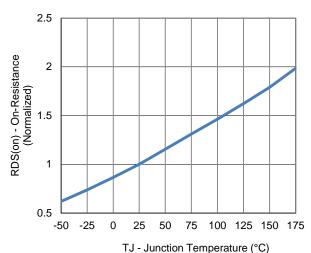


4. Drain-to-Source Forward Voltage

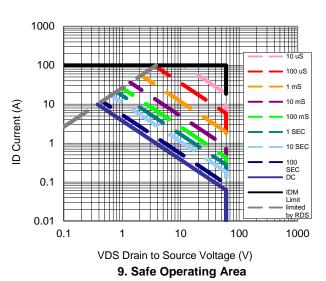


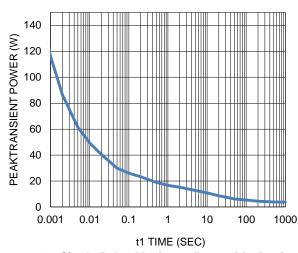
Typical Electrical Characteristics



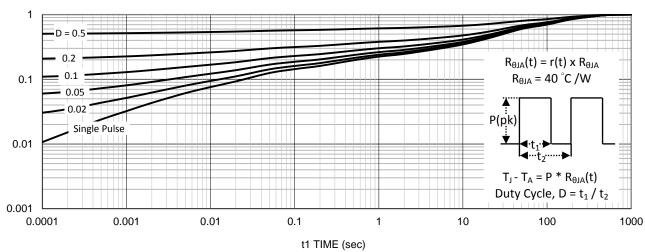


8. Normalized On-Resistance Vs
Junction Temperature



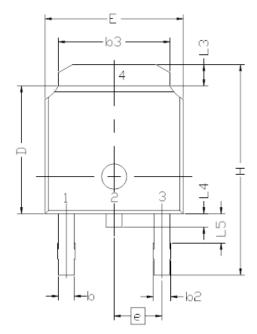


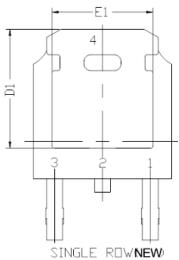
10. Single Pulse Maximum Power Dissipation

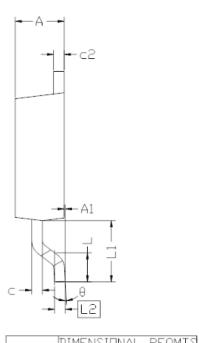


11. Normalized Thermal Transient Junction to Ambient

Package Information







| CVMDDI | DIMENS: | IDNAL F | REQMTS | | | |
|--------|-----------|-----------|--------|--|--|--|
| SYMBOL | MIN | NDM | MAX | | | |
| E | 6.40 | 6.60 | 6.731 | | | |
| L | 1.40 | 1.52 | 1.77 | | | |
| L1 | 2.743 REF | | | | | |
| L2 | 0. | 0,508 BSC | | | | |
| _L3 | 0.89 | | 1.27 | | | |
| L4 | 0.64 | | 1.01 | | | |
| L5 | | | | | | |
| D | 6.00 | 6.10 | 6,223 | | | |
| Н | 9.40 | 10.00 | 10.40 | | | |
| b | 0.64 | 0.76 | 0,88 | | | |
| b2 | 0.77 | 0.84 | 1.14 | | | |
| b3 | 5,21 | 5.34 | 5,46 | | | |
| е | 2. | 286 BS | Č | | | |
| e A | 2,20 | 2.30 | 2,38 | | | |
| A1 | 0 | | 0.127 | | | |
| C | 0.45 | 0.50 | 0.60 | | | |
| c2 | 0.45 | 0.50 | 0.58 | | | |
| D1 | 5,30 | | | | | |
| E1 | 4.40 | | | | | |
| θ | 0° | | 10° | | | |

Note:

- 1. All Dimension Are In mm.
- 2. Package Body Sizes Exclude Mold Flash, Protrusion Or Gate Burrs. Mold Flash, Protrusion Or Gate Burrs Shall Not Exceed 0.10 mm Per Side.
- 3. Package Body Sizes Determined At The Outermost Extremes Of The Plastic Body Exclusive Of Mold Flash, Gate Burrs And Interlead Flash, But Including Any Mismatch Between The Top And Bottom Of The Plastic Body.